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Renesas Technology Corp. Customer Support Dept. April 1, 2003



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Silicon NPN Triple Diffused

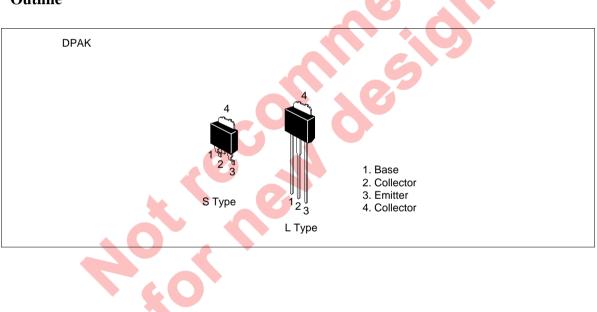
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ADE-208-893 (Z) 1st. Edition September 2000

### Application

High speed and high voltage switching

#### Outline



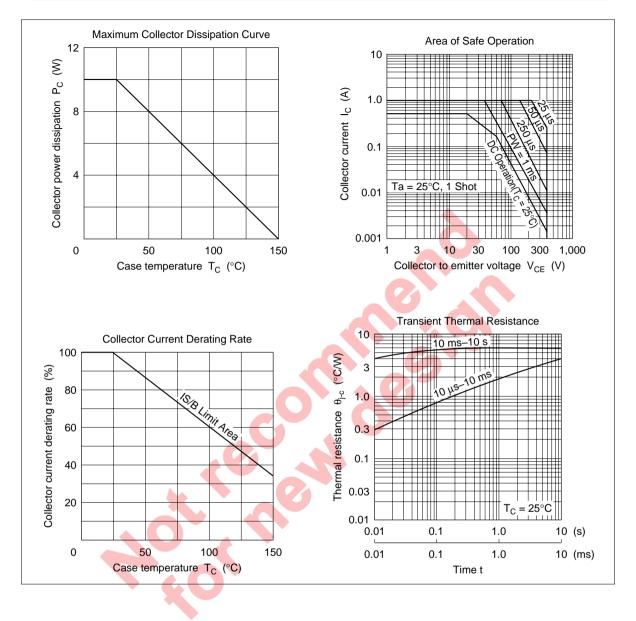
#### **Absolute Maximum Ratings** (Ta = 25°C)

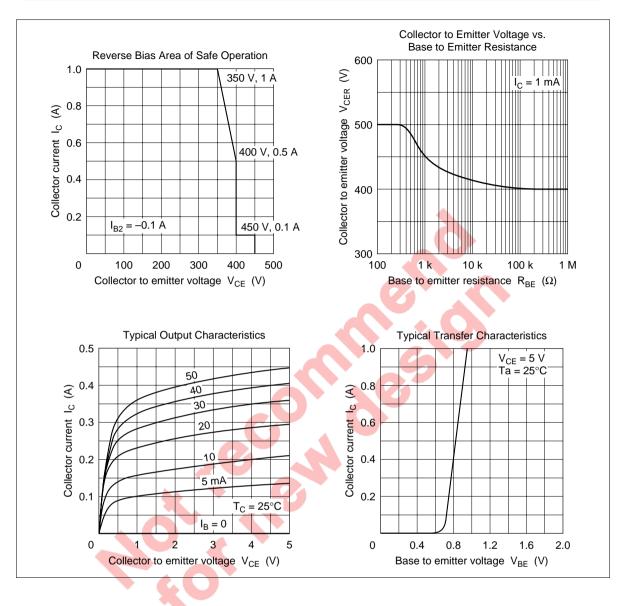
Item	Symbol	Ratings	Unit			
Collector to base voltage	V <sub>CBO</sub>	500	V			
Collector to emitter voltage	V <sub>CEO</sub>	400	V			
Emitter to base voltage	V <sub>EBO</sub>	10	V			
Collector current	I <sub>c</sub>	0.5	А			
Collector peak current	I <sub>C(peak)</sub>	1.0	A			
Collector power dissipation	P <sub>c</sub>	0.75	W			
	Pc*1	10				
Junction temperature	Тј	150	°C			
Storage temperature	Tstg	-55 to +150	°C			
Note: 1. Value at $T_c = 25^{\circ}C$ . Electrical Characteristics (Ta = 25°C)						

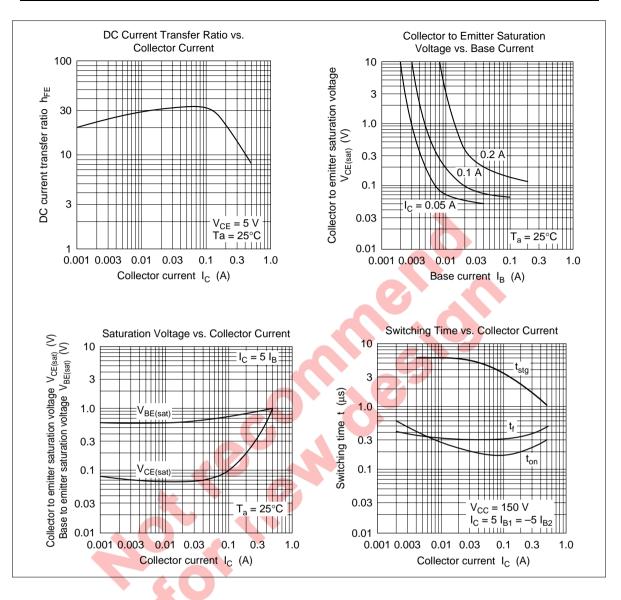
#### **Electrical Characteristics** (Ta = $25^{\circ}$ C)

ltem	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to emitter sustain voltage	$V_{\text{CEO}(\text{sus})}$	400		-	V	$I_{c} = 0.1 \text{ A}, R_{BE} = \infty$ L = 100 mH
Emitter to base breakdown voltage	V <sub>(BR)EBO</sub>	10	_	0	V	$I_{\rm E} = 10$ mA, $I_{\rm C} = 0$
Collector cutoff current	I <sub>CBO</sub>	—		20	μA	$V_{CB} = 400 \text{ V}, I_{E} = 0$
	I <sub>CEO</sub>	—	_	50		$V_{ce}$ = 350 V, $R_{be}$ = $\infty$
DC current transfer ratio	h <sub>FE1</sub>	12		_		$V_{ce} = 5 \text{ V}, \text{ I}_{c} = 0.25 \text{ A}^{*1}$
	h <sub>FE2</sub>	5	—	_		$V_{ce} = 5 \text{ V}, \text{ I}_{c} = 0.5 \text{ A}^{*1}$
Collector to emitter saturation voltage	$V_{CE(sat)}$		—	1.0	V	$I_{c} = 0.25 \text{ A}, I_{B} = 0.05 \text{ A}^{*1}$
Base to emitter saturation voltage	V <sub>BE(sat)</sub>	_	_	1.5	V	$I_{c} = 0.25 \text{ A}, I_{B} = 0.05 \text{ A}^{*1}$
Turn on time	t <sub>on</sub>	_	_	1.0	μs	$I_{\rm C} = 0.5 \text{ A}, I_{\rm B1} = -I_{\rm B2} = 0.1 \text{ A},$
Storage time	t <sub>stg</sub>	_	_	2.0	μs	$V_{cc} \cong 150 \text{ V}$
Fall time	t <sub>f</sub>	—	_	1.0	μs	_

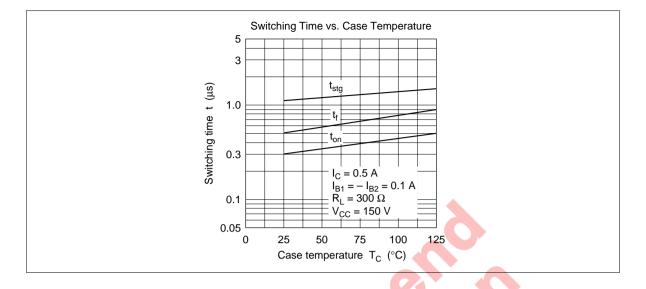
Note: 1. Pulse test.







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#### Hitachi, Ltd.

Semiconductor & IC Div. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100, Japan Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

#### For further information write to:

Hitachi America, Ltd. Semiconductor & IC Div. 2000 Sierra Point Parkway Brisbane, CA. 94005-1835 U S A Tel: 415-589-8300 Fax: 415-583-4207 Hitachi Europe GmbH Electronic Components Group Continental Europe Dornacher Straße 3 D-85622 Feldkirchen München Tel: 089-9 91 80-0 Fax: 089-9 29 30 00 Hitachi Europe Ltd. Electronic Components Div. Northern Europe Headquarters Whitebrook Park Lower Cookham Road Maidenhead Berkshire SL6 8YA United Kingdom Tel: 0628-585000 Fax: 0628-778322 Hitachi Asia Pte. Ltd. 16 Collyer Quay #20-00 Hitachi Tower Singapore 0104 Tel: 535-2100 Fax: 535-1533

Hitachi Asia (Hong Kong) Ltd. Unit 706, North Tower, World Finance Centre, Harbour City, Canton Road Tsim Sha Tsui, Kowloon Hong Kong Tel: 27359218 Fax: 27306071



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